

Open issues from last week's meeting with Linac Group:

1. Update top-view diagram per discussion at telecon
2. How many crates/racks for each RF building block for controls + LLRF + instrumentation?
3. Stepper motor package:
 - Control
 - Readback of position and status
 - Cabling & connectors
 - Relay rack usage
 - Power dissipation
4. Relay rack layout in service tunnel (need to give info to Ray)
5. Cable counts and penetration usage
6. Number of sensors and instrument channels/devices in each cryomodule (Jim P)
7. Number of vacuum devices (Carwardine to follow up with Noonan)
8. Cable tray needs
9. Power and cooling requirements
10. Test & integration facilities: what do we want to cost?